

# SEMI International Standards Program Japan Silicon Wafer TC Chapter Meeting

Thursday, December 13, 2018, 14:00-17:00  
Conference Tower, Tokyo Big Sight, Tokyo, Japan

## AGENDA

1. **Welcome, Reminders, and Introductions**
  - 1.1. Welcome
  - 1.2. Self-Introduction
  - 1.3. Reminders
    - 1.3.1. Program Membership Requirement
    - 1.3.2. Anti-Trust Reminder
    - 1.3.3. Intellectual Property Reminder
    - 1.3.4. International Effective Meeting Guidelines
  - 1.4. Agenda Review
2. **Review of Previous Meeting Minutes**
3. **Liaison Reports**
  - 3.1. Silicon Wafer GCS Report (Chair)
  - 3.2. North America Silicon Wafer Committee Report (Chair)
  - 3.3. Europe Silicon Wafer Committee Report (Chair)
  - 3.4. JSNM / M4S (Material Standards Study Group for Semiconductor Supply-Chain) Report (Yoshise-san)
  - 3.5. SEMI Staff Report
4. **Ballot Review: NO ballot review**
5. **Subcommittee and Task Force Report**
  - 5.1. International 450mm Shipping Box Task Force (Komatsu-san/Nagashima-san)/ JA Shipping Box Task Force (Komatsu-san/Nagashima-san)
  - 5.2. International Advanced Wafer Geometry Task Force/ Japan AWG Task Force (Akiyama-san/ Yoshise-san)
  - 5.3. International Test Methods Task Force (Takeda-san) Japan Test Method Task Force (Takeda-san/ Otsuki-san/ Omata-san)
    - SNARF: New Standard Document: Test Method for Bulk Microdefect density and Denuded Zone Width in Annealed Silicon Wafers by Preferential Etching Technique
    - SNARF: New Standard Document: Guide for Measuring Bulk Micro Defect Density and Denuded Zone Width in Annealed Silicon Wafers by a Laser-Scatter Tomography Technique
  - 5.4. International Polished Wafers Task Force (Takamori-san)
  - 5.5. International Epitaxial Wafers Task Force (Toda-san)
  - 5.6. International Annealed Wafers Task Force (Araki-san)
  - 5.7. International SOI Wafers Task Force (Ogura-san/ Nakai-san)
  - 5.8. International Terminology Task Force (Nakai-san)
  - 5.9. International Advanced Automated Surface Inspection Task Force (Ikota-san)
6. **Old Business**

- 6.1. Previous Action Items
- 6.2. 3-years Project Period
- 6.3. Consideration of 5-year review
- 6.4. Others (if any)

7. **New Business**

- 7.1. If any

8. **Action Item Review, Next Meeting and Adjournment**